

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
20V	250mΩ@4.5V	0.75A
	350mΩ@2.5V	

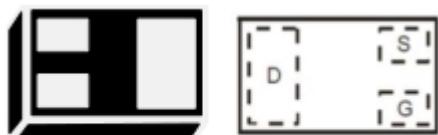
Feature

- Surface Mount Package
- N-Channel Switch with Low RDS(on)
- Operated at Low Logic Level Gate Drive
- ESD Protected: HBM 2kV

Applications

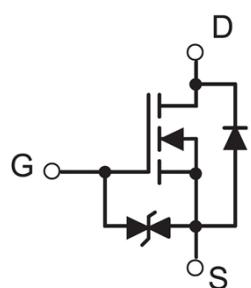
- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

Package

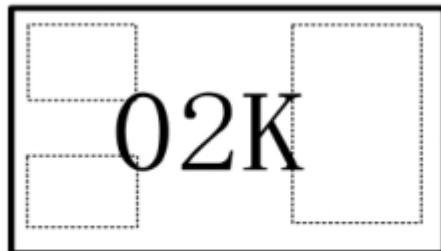


DFN1006-3L

Circuit diagram



Marking



02K =Device Code

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

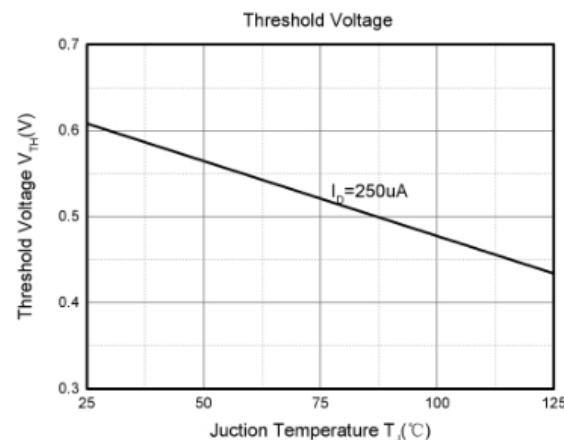
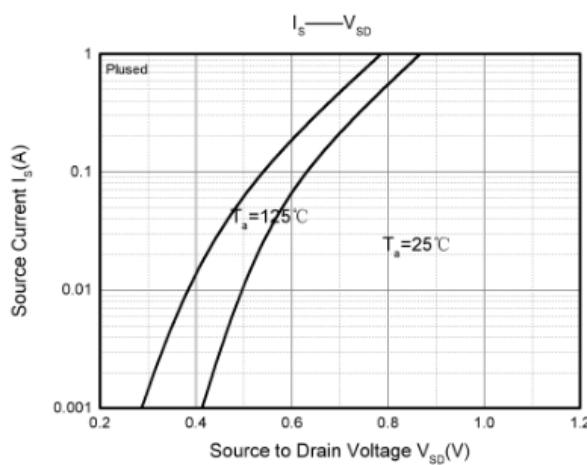
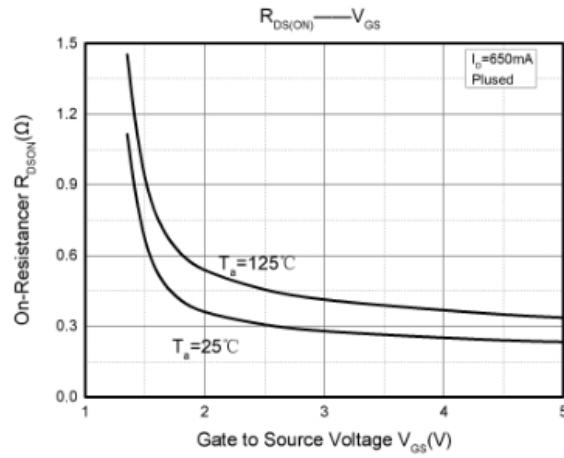
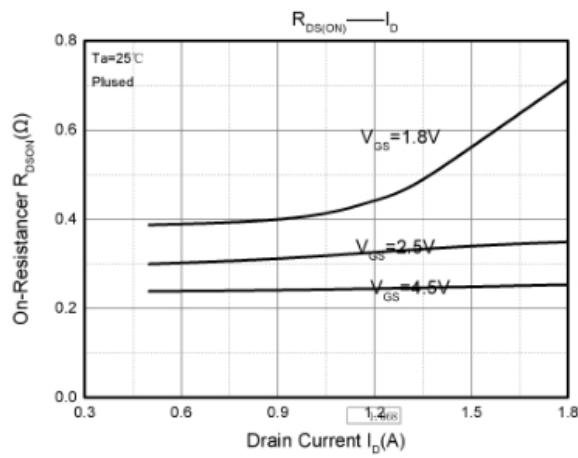
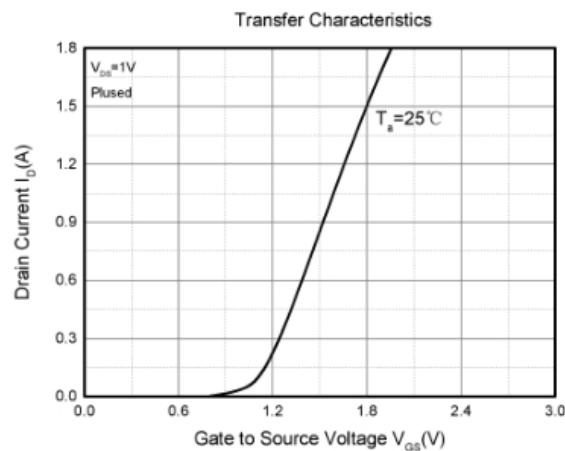
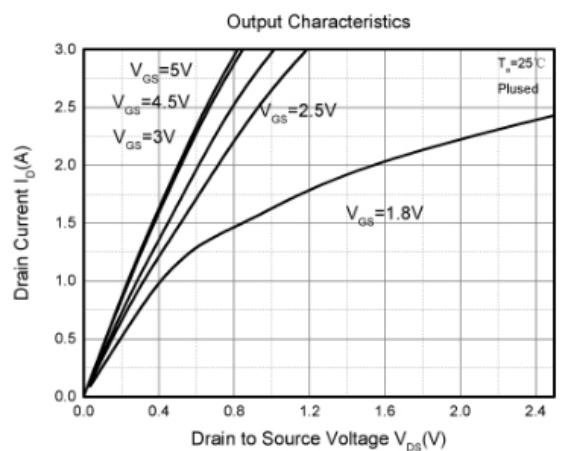
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	0.75	A
Pulsed Drain Current	I_{DM}	3.0	A
Power Dissipation	P_D	0.15	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	833	$^\circ\text{C}/\text{W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature	$T_{STG..}$	-55~+150	$^\circ\text{C}$

Electrical characteristics

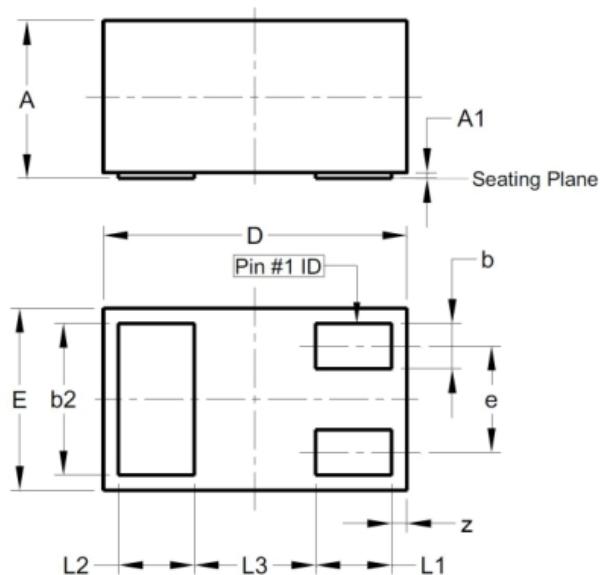
($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$\text{BV}_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	20			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 16\text{V}, V_{GS} = 0\text{V}$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 10\text{V}, V_{DS} = 0\text{V}$			± 10	μA
Gate threshold voltage ⁽¹⁾	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.3	0.65	1	V
Drain-source on-resistance ⁽¹⁾	$R_{DS(\text{on})}$	$V_{GS} = 4.5\text{V}, I_D = 0.5\text{A}$		0.25	0.38	$\text{m}\Omega$
		$V_{GS} = 2.5\text{V}, I_D = 0.5\text{A}$		0.35	0.45	
Dynamic Characteristics						
Input capacitance	C_{iss}	$V_{DS} = 16\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$		79	120	pF
Output capacitance	C_{oss}			13	20	
Reverse transfer capacitance	C_{rss}			9	15	
Switching Parameters						
Turn-on Delay Time	$T_{d(on)}$	$V_{GS} = 4.5\text{V}, V_{DS} = 10\text{V}, I_D = 500\text{mA}, R_{GEN} = 10\Omega$		6.7		nS
Turn-on Rise Time	T_r			4.8		
Turn-Off Delay Time	$T_{d(off)}$			17.3		
Turn-Off Fall Time	t_f			7.4		
Source-Drain Diode Characteristics						
Body Diode Voltage	V_{SD}	$I_S = 0.5\text{A}, V_{GS} = 0\text{V}$		0.7	1.2	V

Typical Characteristics



DFN1006-3L Package Information



Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	0.47	0.50	0.55
A1	0.00	-	0.05
b	0.10	0.15	0.20
b2	0.45	0.50	0.55
D	0.95	1.0	1.05
E	0.55	0.60	0.65
e	0.35BSC		
L1	0.20	0.25	0.30
L2	0.20	0.25	0.30
L3	0.40		
z	0.02	0.05	0.08